

/ Descriptions

SOT-23 PNP Silicon PNP transistor in a SOT-23 Plastic Package.

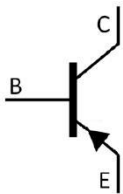
/ Features

h_{FE} , 2SD596
High h_{FE} , complementary pair with 2SD596.

/ Applications

Audio frequency amplifier application.

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Emitter PIN 3 Collector

/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	1	2	3	4	5
h_{FE} Range	110~180	135~220	170~270	200~320	250~400
Marking	HBV1	HBV2	HBV3	HBV4	HBV5

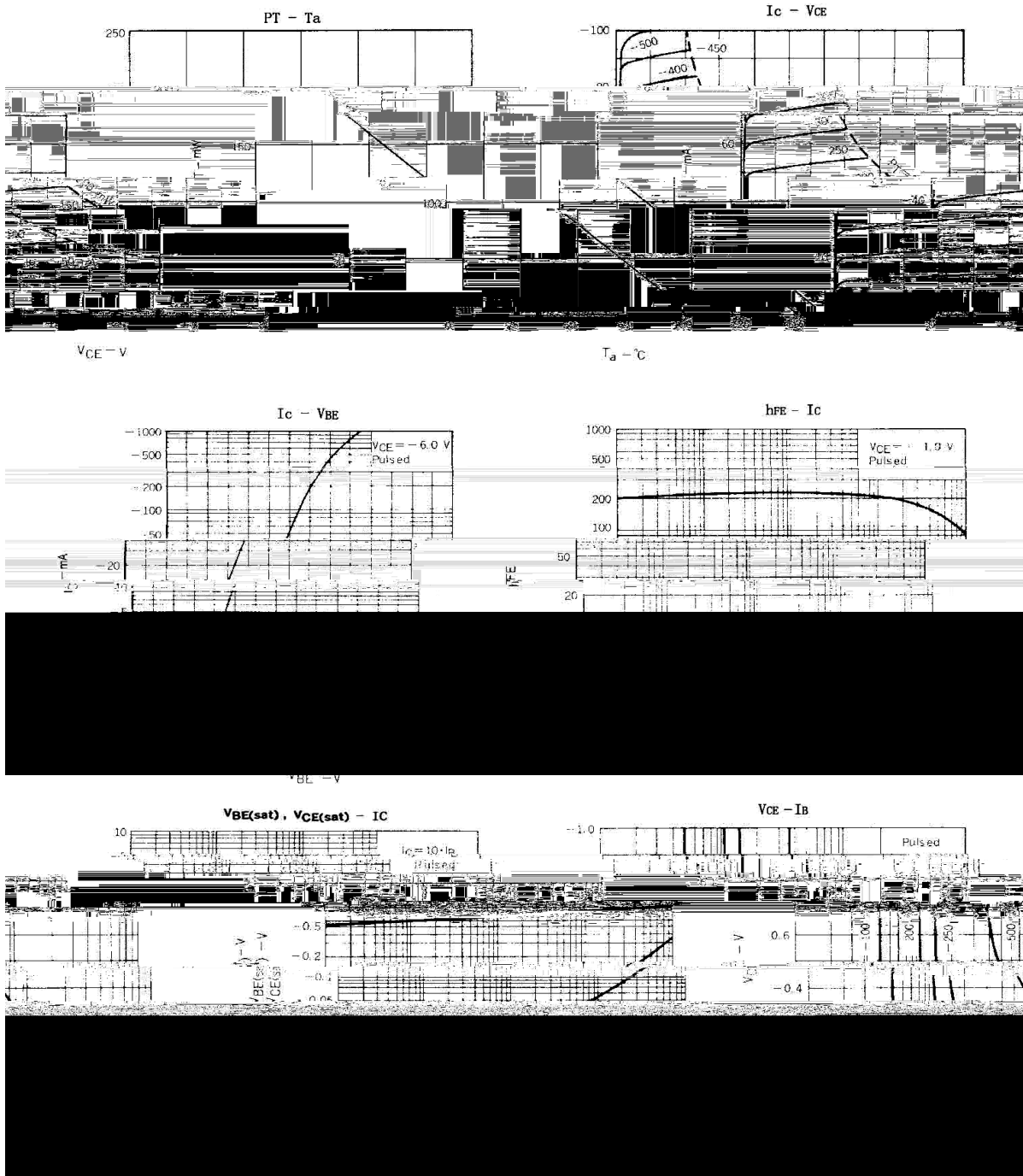
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-30	V
Collector to Emitter Voltage	V_{CEO}	-25	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current	I_C	-700	mA
Collector Power Dissipation	P_C	200	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55~150	

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-30V$ $I_E=0$			-0.1	A
Emitter Base Cut-Off Current	I_{EBO}	$V_{EB}=-5.0V$ $I_C=0$			-0.1	A
DC Current Gain	$h_{FE(1)}$	$V_{CE}=-1.0V$ $I_C=-100mA$	110	200	400	
	$h_{FE(2)}$	$V_{CE}=-1.0V$ $I_C=-700mA$	50			
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-700mA$ $I_B=-70mA$		-0.25	-0.6	V
Collector to Base Voltage	V_{BE}	$V_{CE}=-6.0V$ $I_C=-10mA$	-0.6	-0.64	-0.7	V
Transition Frequency	f_T	$V_{CE}=-6.0V$ $I_E=10mA$		160		MHz
Collector Output Capacitance	C_{ob}	$V_{CB}=-6.0V$ $I_E=0$ $f=10MHz$		17		pF

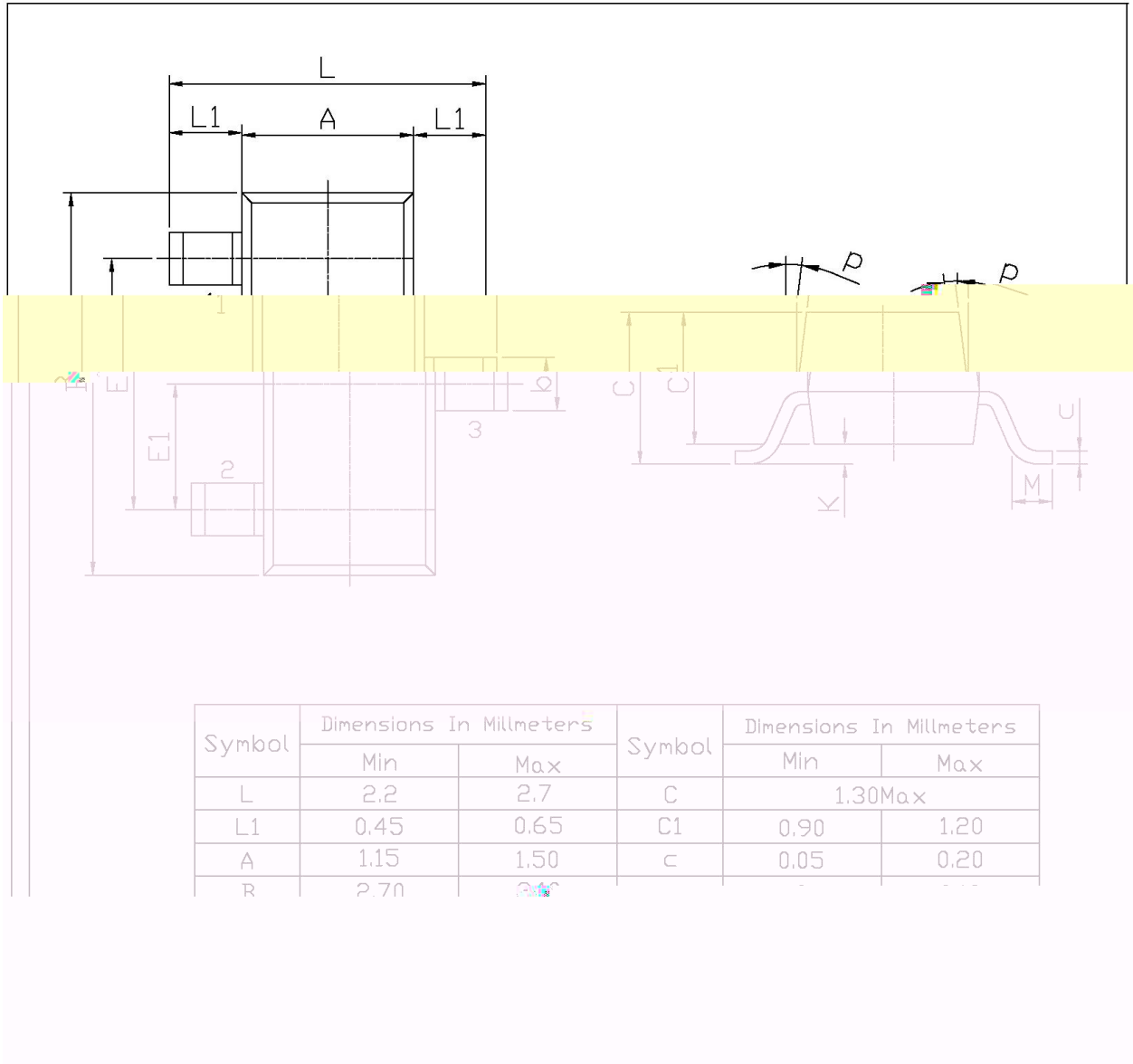
/ Electrical Characteristic Curve



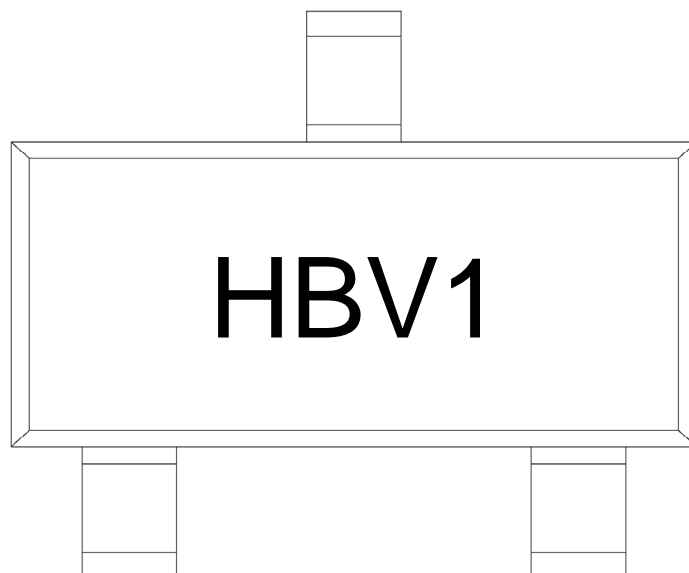
/ Package Dimensions

SOT-23

单位: mm



/ Marking Instructions



H

BV

1 h_{FE}

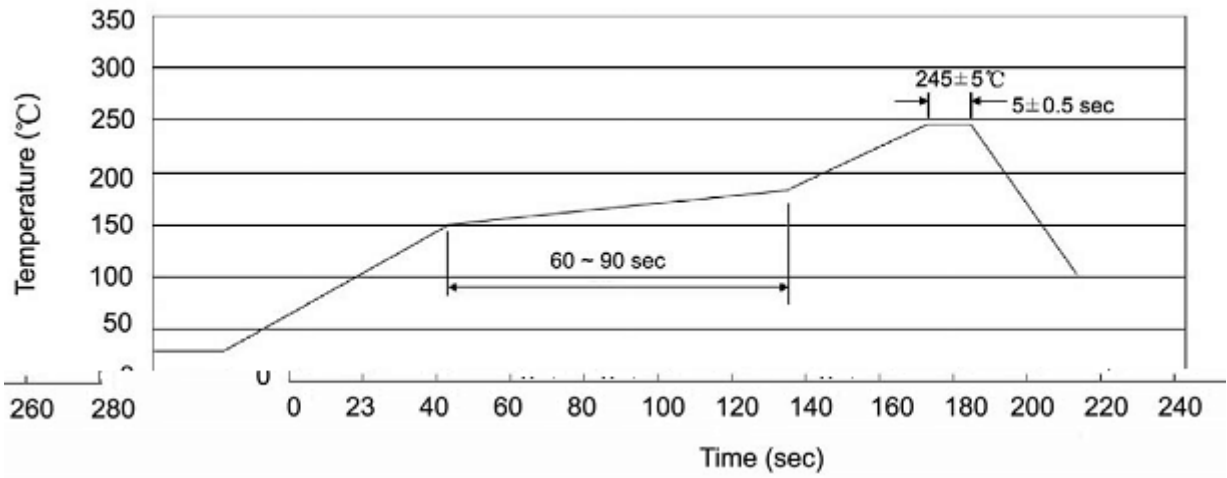
Note:

H: Company Code.

BV: Product Type Code

1: h_{FE} Classifications Symbol Code

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- | | | | | | |
|---|-------|-----|-----------|--------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 245±5 | | 5±0.5sec; | | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | | 2 | 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	只卷盘	卷盘盒	只盒	盒箱	只箱		盒	箱
						"		

/ Notices